A 60 to 77 GHz Switchable LNA in an RF-MEMS Embedded BiCMOS Technology
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Abstract—In this letter, a 60 to 77 GHz switchable low-noise amplifier is presented. The IC is realized in a radio frequency microelectromechanical systems embedded 0.25 μm SiGe-C BiCMOS technology. Measured results show that the presented IC achieves good performance in both frequency bands in terms of gain, noise figure and power consumption. These results demonstrate the successful monolithic integration of RF-MEMS switches with active devices, and a first time implementation of a reconfigurable low noise amplifier at such high frequencies.

Index Terms—BiCMOS integrated circuits (ICs), dual band, low-noise amplifiers (LNAs), millimeter wave integrated circuits, MMICs, radio frequency microelectromechanical systems (RF-MEMS), switches, tunable circuits and devices.

I. INTRODUCTION

Radio frequency microelectromechanical systems (RF-MEMS) are an interesting research topic, as RF-MEMS components increasingly find applications in several areas at X-band to millimeter-wave frequencies [1]. In general, integration of RF-MEMS components in electronics is a major problem in terms of cost and addition of interconnect parasitics. This limits the range of potential applications, especially for higher frequencies. In that sense, cofabrication of RF-MEMS and electronic devices would be very advantageous [2], and such integration potentially would open up more application windows for RF-MEMS. One example of such integration can be found in [3], where an X-band, dual-path power amplifier is presented, which utilizes RF-MEMS switches that are fabricated on the same GaAs substrate.

In this work, a reconfigurable LNA in a back end of line (BEOL) embedded RF-MEMS technology is presented. Using the same technology, a 3 to 4 GHz switchable voltage controlled oscillator has already been presented in [4], and this work extends the applicability to millimeter-wave frequencies, by presenting novel results of a 60 to 77 GHz switchable LNA.

II. TECHNOLOGY

In Fig. 1 the cross section of the RF-MEMS switch is displayed. The core technology is the IHP SG25H1 0.25 μm SiGe-C BiCMOS with five metal layers (M1-5). The switch consists of an M3 membrane, an M2 signal line and the actuation electrodes on M1. It is realized by the removal of the SiO2 in the switch area by wet etching, which adds only one additional mask layer to the standard technology process. The released M3 membrane bends upward due to residual mechanical stress, which is optimized by rigorous mechanical simulations and process optimization [4]. When an actuation voltage is applied on the M1 electrodes, the membrane is pulled down making contact with the TiN layer above the M2 signal line. The TiN layer and the dielectric layer underneath is technology standard for MIM capacitors. This mechanical movement results in a high or low capacitance between the membrane and the signal line for the down or up positions of the membrane, respectively. Typical actuation voltage is in the range of 20–25 V, while for reliable operation 40 V is recommended. The switching time is around 4 to 5 μs.

In Fig. 2, the top view and the dimensions of the membrane and the signal line are displayed. The membrane has four supporting beams which are connected to the ac ground of the circuit. For electrical modeling, the signal line and the membrane are EM-simulated in ADS Momentum, while the switch capacitance is included as a lumped component between the two structures. The value of the switch capacitance is extracted from CV measurements, and equals 22 fF for the up-state, and 220 fF for the down-state.

In Fig. 3, the simulated performance of the switch is displayed for the up- and down-states. The simulations show an insertion loss less than 1 dB up to 100 GHz, and an isolation better than
III. Circuit Design

The schematic of the 60/77 GHz switchable LNA is shown in Fig. 4. The LNA consists of two stages of cascode amplifiers. The inductors \( L_{1-8} \) are realized as thin-film-microstrip lines between M5 and M1. Considering the approximate behavior of the RF-MEMS switches shown in Fig. 2, the most convenient way to integrate the switch into the design is including it as part of a reconfigurable transmission line. This is done here for the loads of the two stages \( L_2/L_3 \) and \( L_6/L_7 \), respectively. These realize tapped inductors in combination with the RF-MEMS switches, where the tap can be shorted to ground by the switch capacitance. If we consider the first stage, when the RF-MEMS switch is in the up-state the total load inductance approximately equals \( L_1 \parallel L_3 \parallel L_4 \), while in the down state the total inductance becomes approximately \( L_4 \parallel L_1 \parallel L_2 \). By this means, the switchable dual-band operation in the desired frequency bands is achieved by properly adjusting the line lengths of \( L_{2-7} \).

A reconfigurable input matching network was not needed, as the two bands of operation are relatively close to each other.

IV. Experimental Results

The chip photograph of the realized 60/77 GHz switchable LNA is displayed in Fig. 5. The total chip area, including measurement pads is \( 0.75 \times 1.05 \text{ mm}^2 \), and the IC consumes a total of 16 mA from a 2.5 V dc voltage source.

In Fig. 6, the measured S-parameters and NF of the designed 60/77 GHz switchable LNA are given for the up-state of the switch.
measurements agree with the simulations, 0 dBm for both states. In general, the performance is 3 dB worse than the simulations, and 0 dB, 3 to 5 dB worse than the simulated value. Because the frequency switching is achieved only by shortening of the load transmission lines, the $S_{22}$ parameter varies from $-5$ dB to $-5$ dB worse than the simulated value.

The results are summarized in Table I, showing the minimum and maximum values of the measured gain and noise figure at 56 GHz for the up-state, and at 72 GHz for the down-state of the RF-MEMS switches. As seen, the designed switchable LNA achieves good performance in both bands, comparable to the state of the art in other BiCMOS technologies [5]–[7]. The switchable LNA outperforms conventional broadband designs, as in such designs more number of stages would be needed to maintain the high gain in both bands. These results verify the successful cofabrication of the RF-MEMS switches with the BiCMOS active devices, opening up many potential application possibilities in the millimeter wave frequency range.

V. CONCLUSION

Novel results of a 60/77 GHz switchable LNA in an RF-MEMS embedded 0.25 $\mu$m SiGe-C BiCMOS technology were presented. The measured samples showed good performance in both bands. The rather good agreement between measurement and simulation results, and the low spread across the wafer demonstrate that the presented technology is well suited for millimeter wave applications.

**REFERENCES**


